



## 48-Channel PWM Constant Current LED Driver for 1:32 Time-Multiplexing Applications

### Features

- 3V-5.5V supply voltage
- 48 constant current output channels
- Constant output current range:
  - 0.5~20mA @ 5V supply voltage
  - 0.5~10mA @ 3.3V supply voltage
- Excellent output current accuracy:
  - Between channels:  $<\pm 2.5\%$ (Max.)
  - Between ICs:  $<\pm 3\%$ (Max.)
- Built-in 48K-bit SRAM to support time-multiplexing for 1 ~ 32 scans
- Flexible PWM control to improve visual refresh rate,
  - 16/15/14/13 bit grayscale mode with programmable scrambling
- Global current gain control:
  - Gain range: 100%~200%, step increment: 14.4%
- 128 steps R/G/B/ individual current gain control
- Integrating ghost elimination circuit
- Premium low grayscale improvement technique
- LED failure isolation
  - LED failure induced cross elimination
- LED status monitoring:
  - LED open detection with programmable threshold levels
  - LED short detection with programmable threshold levels
- Smart power saving mode
- GCLK multiplier technology
- Maximum DCLK frequency: 30MHz
- Package MSL Level : 3



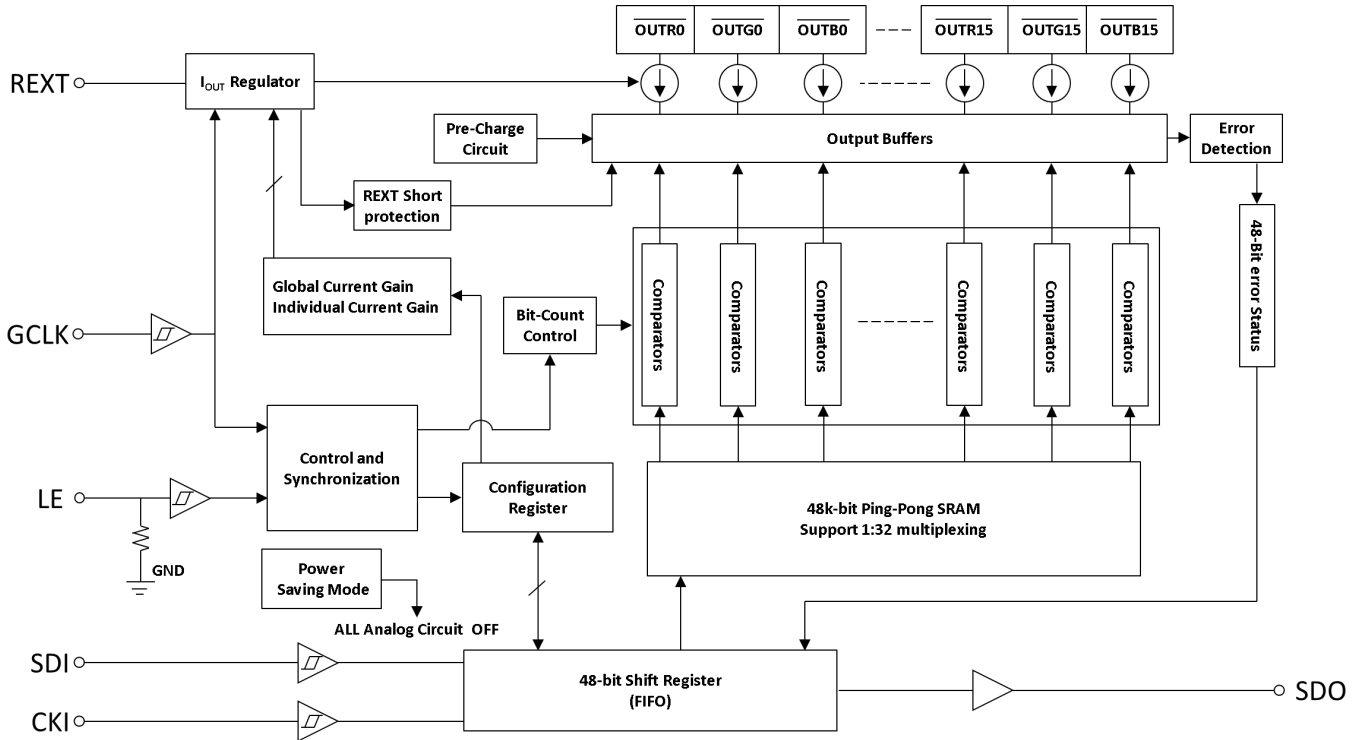
### Product Description

MBI5353 is designed for LED video applications using internal Pulse Width Modulation (PWM) control with selectable 16 /15 /14 / 13-bit color depth. MBI5353 features a 48-bit shift register which converts serial input data into each pixel's gray scale of the output port. The forty-eight regulated current ports are designed to provide uniform and constant current sinks for driving LEDs with a wide range of  $V_F$  variations. The output current can be preset through an external resistor. The innovative architecture with embedded SRAM is designed to support up to 1:32 time-multiplexing applications. Users only need to send the whole frame data once and to store in the embedded SRAM of the LED driver, instead of sending every time when the scan line is changed. It helps to save the data bandwidth and to achieve high grayscale with very low data clock rate. With scan-type Scrambled-PWM (S-PWM) technology, MBI5353 enhances PWM by scrambling the "on" time of each scan line into several "on" periods and sequentially drives each scan line for a short "on" period. The enhancement equivalently increases the visual refresh rate of scan-type LED displays. In addition, the innovative GCLK multiplier technique doubles visual refresh rate.

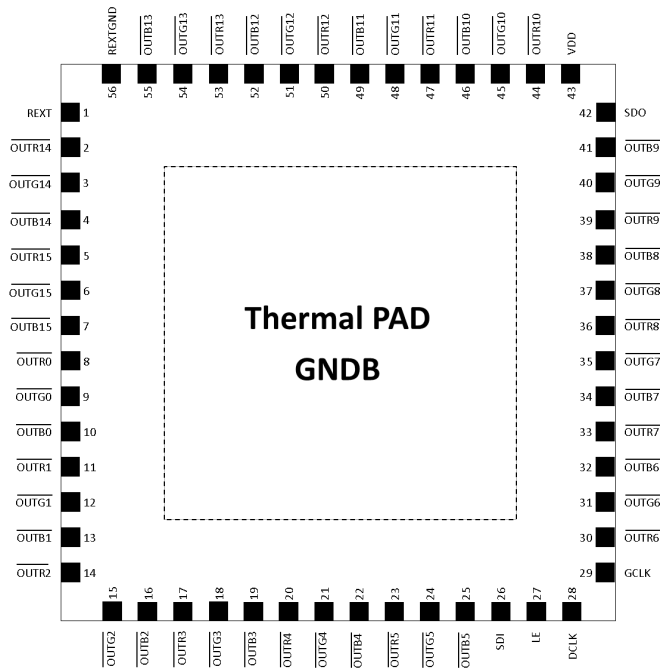
MBI5353 drives the corresponding LEDs to the brightness specified by image data. With MBI5353, all output channels can be built with 16-bit color depth (65,536 gray scales). When building a 16-bit color depth video, S-PWM technology reduces the flickers and improves the image fidelity.

Through compulsory error detection, MBI5353 detects individual LED for open-circuit errors without extra components. MBI5353 equips an innovative cross elimination function, and it solves the cross phenomenon induced by failure LEDs. Besides, integrated ghost elimination circuit eases the ghost problems. To further reduce power consumption of LED display, a built-in smart power saving mode will shut driver IC down when grayscale data is zero.

**Block Diagram**



**Pin Configuration**



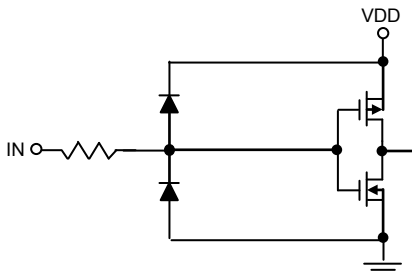
MBI5353GFN

**Terminal Description**

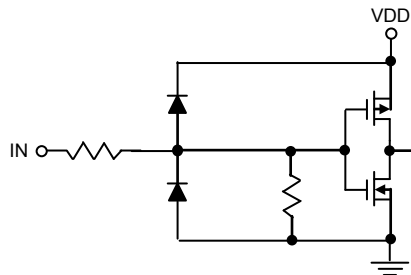
Pin Name	Pin Number	Function
VDD	43	3.3V/5V supply voltage terminal
GNDB	Thermal Pad	Ground terminal for control logic and current sink
SDI	26	Serial-data input to the shift register
DCLK	28	Clock input terminal used to shift data on rising edge and carries command information when LE is asserted.
LE	27	Data strobe terminal and controlling command with DCLK
GCLK	29	Gray scale clock terminal Clock input for gray scale. The gray scale display is counted by gray scale clock compared with input data.
SDO	42	Serial-data output to the receiver-end SDI of next LED driver
REXT	1	Input terminal used to connect an external resistor for setting up output current for all output channels
REXTGND	56	Ground pin for the external resistor. This pin should be connected to analog ground trace which is connected to power ground near the common GND point of board.
OUTR0-OUTR15	2, 5, 8, 11, 14, 17, 20, 23, 30, 33, 36, 39, 44, 47, 50, 53	Constant current output terminals for RLED
OUTG0-OUTG15	3, 6, 9, 12, 15, 18, 21, 24, 31, 34, 37, 40, 45, 48, 51, 54	Constant current output terminals for GLED
OUTB0-OUTB15	4, 7, 10, 13, 16, 19, 22, 25, 32, 35, 38, 41, 46, 49, 52, 55	Constant current output terminals for BLED

**Equivalent Circuits of Inputs and Outputs**

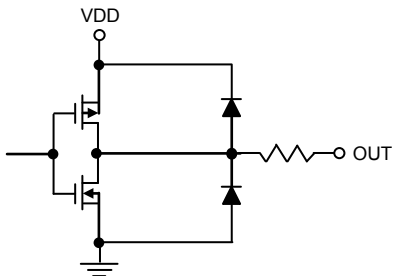
**GCLK, DCLK, SDI terminal**



**LE Terminal**



**SDO Terminal**



**Maximum Rating**

Characteristic		Symbol	Rating	Unit
Supply Voltage		$V_{DD}$	0~5.5	V
Input Pin Voltage (SDI, DCLK, GCLK, LE)		$V_{IN}$	-0.4~ $V_{DD}+0.4$	V
Sustaining Voltage at OUT Port		$V_{DS}$	-0.5~17	V
Output Current		$I_{OUT}$	+22	mA
GND Terminal Current		$I_{GND}$	1100	mA
Power Dissipation (On 4 Layer PCB, $T_a=25^{\circ}C$ )*	GFN Type	$P_D$	3.45	W
Thermal Resistance (On 4 Layer PCB, $T_a=25^{\circ}C$ )*	GFN Type	$R_{th(j-a)}$	29	$^{\circ}C/W$
Junction Temperature		$T_{j,max}$	150**	$^{\circ}C$
Operating Ambient Temperature		$T_{opr}$	-40~+85	$^{\circ}C$
Storage Temperature		$T_{stg}$	-55~+150	$^{\circ}C$
ESD Rating	HBM (MIL-STD-883G Method 3015.7, Human Body Mode)	HBM	Class 2 (3.5KV)	-
	MM (JEDEC EIA/JESD22-A115, Machine Mode)	MM	Class M3 (300V)	-

\*The PCB size is 76.2mm\*114.3mm in simulation. Please refer to JEDEC JESD51.

\*\* Operation at the maximum rating for extended periods may reduce the device reliability; therefore, the suggested junction temperature of the device is under 125 $^{\circ}C$ .

Note: The performance of thermal dissipation is strongly related to the size of thermal pad, thickness and layer numbers of the PCB. The empirical thermal resistance may be different from simulative value. User should plan for expected thermal dissipation performance by selecting package and arranging layout of the PCB to maximize the capability.

**Electrical Characteristics (V<sub>DD</sub>=5.0V, Ta=25°C)**

Characteristics		Symbol	Condition	Min.	Typ.	Max.	Unit
Supply Voltage		V <sub>DD</sub>	-	4.5	5.0	5.5	V
Sustaining Voltage at OUT Ports		V <sub>DS</sub>	OUTR0~OUTB15	-	-	17.0	V
Output Current		I <sub>OUT</sub>	Refer to “Test Circuit for Electrical Characteristics”	0.5	-	20	mA
		I <sub>OH</sub>	SDO	-	-	-1.0	mA
		I <sub>OL</sub>	SDO	-	-	1.0	mA
Input Voltage	“H” level	V <sub>IH</sub>	Ta=-40~85°C	0.7xV <sub>DD</sub>	-	5.0	V
	“L” level	V <sub>IL</sub>	Ta=-40~85°C	GND	-	1.5	V
Output Leakage Current		I <sub>OH</sub>	V <sub>DS</sub> =17.0V	-	-	0.5	µA
Output Voltage	SDO	V <sub>OH</sub>	I <sub>OH</sub> =-1.0mA	V <sub>DD</sub> -0.4	-	-	V
		V <sub>OL</sub>	I <sub>OL</sub> =+1.0mA	-	-	0.4	V
Current Skew (Channel)		dI <sub>OUT1</sub>	I <sub>OUT</sub> =1mA V <sub>DS</sub> =1.0V R <sub>ext</sub> =14kΩ	-	±1.5	±2.5	%
Current Skew (IC)		dI <sub>OUT2</sub>	I <sub>OUT</sub> =1mA V <sub>DS</sub> =1.0V R <sub>ext</sub> =14kΩ	-	±1.5	±3.0	%
Output Current vs. Output Voltage Regulation*		%/dV <sub>DS</sub>	V <sub>DS</sub> within 1.0V and 3.0V, R <sub>ext</sub> =1.4KΩ@10mA	-	±0.1	±0.3	% / V
Output Current vs. Supply Voltage Regulation*		%/dV <sub>DD</sub>	V <sub>DD</sub> within 4.5V and 5.5V R <sub>ext</sub> =1.4KΩ@10mA	-	±1.0	±2.0	% / V
LED Open Detection Threshold		V <sub>OD,TH</sub>	-	-	0.5	-	V
LED Short Detection Threshold		V <sub>SD,TH</sub>	-	-	2.4	-	V
R <sub>EXT</sub> short Detection Threshold		V <sub>reshort</sub>	V <sub>REXT</sub> < 0.25V, Channel=OFF				V
Pull-down Resistor		R <sub>IN(down)</sub>	LE	250	450	800	KΩ
Supply Current	“Off” (SDI=DCLK=GCLK=0Hz)	I <sub>DD(off) 1</sub>	R <sub>ext</sub> =open OUTR0~OUTB15=Off; ICG & GCG are set to default value	-	6.5	-	mA
		I <sub>DD(off) 2</sub>	R <sub>ext</sub> =2.65 KΩ, OUTR0~OUTB15=Off; ICG & GCG are set to default value	-	10	-	
		I <sub>DD(off) 3</sub>	R <sub>ext</sub> =890 KΩ, OUTR0~OUTB15=Off; ICG & GCG are set to default value	-	15	-	
	“On” (SDI= DCLK=5MHz, GCLK=20MHz)	I <sub>DD(on) 1</sub>	R <sub>ext</sub> =2.65 KΩ, OUTR0~OUTB15=On; ICG & GCG are set to default value	-	10	-	
		I <sub>DD(on) 2</sub>	R <sub>ext</sub> =890 KΩ, OUTR0~OUTB15=On; ICG & GCG are set to default value	-	15	-	

\* One channel on.

\*\* ICG: Individual Current Gain, please refer to R/G/B individual configuration register 1[8:2]

\*\*\* GCG: Global Current Gain, please refer to global configuration register 2[A:6]

**Electrical Characteristics (V<sub>DD</sub>=3.3V, Ta=25°C)**

Characteristics		Symbol	Condition	Min.	Typ.	Max.	Unit
Supply Voltage		V <sub>DD</sub>	-	3.0	3.3	3.6	V
Sustaining Voltage at OUT Ports		V <sub>DS</sub>	OUTR0~OUTB15	-	-	17.0	V
Output Current		I <sub>OUT</sub>	Refer to "Test Circuit for Electrical Characteristics"	0.5	-	20	Ma
		I <sub>OH</sub>	SDO	-	-	-1.0	Ma
		I <sub>OL</sub>	SDO	-	-	1.0	mA
Input Voltage	"H" level	V <sub>IH</sub>	Ta=-40~85°C	0.7xV <sub>DD</sub>	-	V <sub>DD</sub>	V
	"L" level	V <sub>IL</sub>	Ta=-40~85°C	GND	-	0.3xV <sub>DD</sub>	V
Output Leakage Current		I <sub>OH</sub>	V <sub>DS</sub> =17.0V	-	-	0.5	Ma
Output Voltage	SDO	V <sub>OH</sub>	I <sub>OH</sub> =-1.0mA	V <sub>DD</sub> -0.4	-	-	V
		V <sub>OL</sub>	I <sub>OL</sub> =+1.0mA	-	-	0.4	V
Current Skew (Channel)		dI <sub>OUT1</sub>	I <sub>OUT</sub> =1mA V <sub>DS</sub> =1.0V R <sub>ext</sub> =14kΩ	-	±1.5	±2.5	%
Current Skew (IC)		dI <sub>OUT2</sub>	I <sub>OUT</sub> =1mA V <sub>DS</sub> =1.0V R <sub>ext</sub> =14kΩ	-	±1.5	±3.0	%
Output Current vs. Output Voltage Regulation*		%/dV <sub>DS</sub>	V <sub>DS</sub> within 1.0V and 3.0V, R <sub>ext</sub> =1.4KΩ@10mA	-	±0.1	±0.3	% / V
Output Current vs. Supply Voltage Regulation*		%/dV <sub>DD</sub>	V <sub>DD</sub> within 4.5V and 5.5V R <sub>ext</sub> =1.4KΩ@10mA	-	±1.0	±2.0	% / V
LED Open Detection Threshold		V <sub>OD,TH</sub>	V <sub>OD,TH</sub> is programmable as 0.5V/1.0V/1.5V/2.0V	-	0.5	-	V
LED Short Detection Threshold		V <sub>SD,TH</sub>	V <sub>OS,TH</sub> is programmable as 2.4V/3.0V/4.0V/4.4V	-	2.4	-	V
R <sub>EXT</sub> short Detection Threshold		V <sub>reshort</sub>	V <sub>REXT</sub> < 0.25V, Channel=OFF				V
Pull-down Resistor		R <sub>IN(down)</sub>	LE	250	450	800	KΩ
Supply Current	"Off" (SDI=DCLK=GCLK=0Hz)	I <sub>DD(off) 1</sub>	R <sub>ext</sub> =open OUTR0~OUTB15=Off; ICG & GCG are set to default value	-	6.5	-	mA
		I <sub>DD(off) 2</sub>	R <sub>ext</sub> =2.65 KΩ, OUTR0~OUTB15=Off; ICG & GCG are set to default value	-	10	-	
		I <sub>DD(off) 3</sub>	R <sub>ext</sub> =890 KΩ, OUTR0~OUTB15=Off; ICG & GCG are set to default value	-	15	-	
	"On" (SDI= DCLK=5MHz, GCLK=20MHz)	I <sub>DD(on) 1</sub>	R <sub>ext</sub> =2.65 KΩ, OUTR0~OUTB15=On; ICG & GCG are set to default value	-	10	-	
		I <sub>DD(on) 2</sub>	R <sub>ext</sub> =890 KΩ, OUTR0~OUTB15=On; ICG & GCG are set to default value	-	15	-	

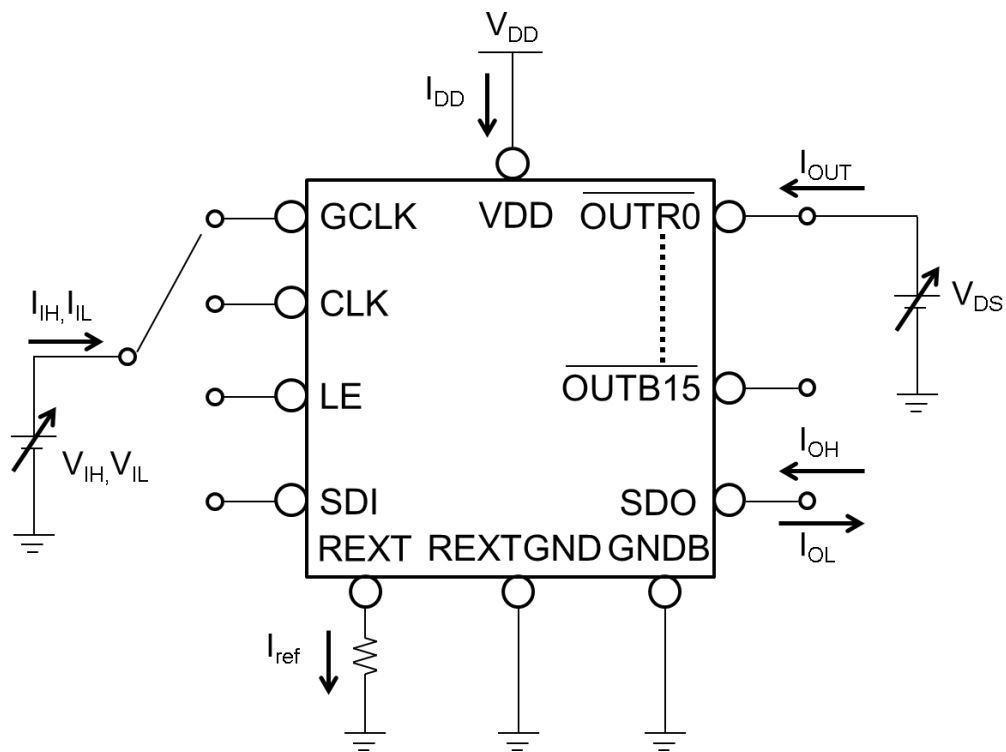
\*One channel on.

\*\* ICG: Individual Current Gain, please refer to R/G/B individual configuration register 1[8:2]

\*\*\* GCG: Global Current Gain, please refer to global configuration register 2[A:6]



Test Circuit for Electrical Characteristics



for 1:32 Time-multiplexing Applications

**Switching Characteristics (V<sub>DD</sub>=5.0V, Ta=25°C)**

Characteristics		Symbol	Condition	Min.	Typ.	Max.	Unit
Setup Time	SDI - DCLK ↑	t <sub>SU0</sub>	V <sub>DD</sub> =5.0V V <sub>IH</sub> =V <sub>DD</sub> V <sub>IL</sub> =GND R <sub>ext</sub> =880Ω V <sub>DS</sub> =0.5V R <sub>L</sub> =300Ω C <sub>L</sub> =10pF C <sub>1</sub> =100nF C <sub>2</sub> =10μF C <sub>SDO</sub> =10pF V <sub>LED</sub> =4V ICG(Dec)=127 GCG(Dec)=8 *I <sub>OUT</sub> =10mA	5	-	-	ns
	LE ↑ - DCLK ↑	t <sub>SU1</sub>		8	-	-	ns
	LE ↓ (VSYNC) - GCLK	t <sub>SU2</sub>		1200			ns
	LE ↓ - DCLK ↑	t <sub>SU3</sub>		50			ns
Hold Time	DCLK ↑ - SDI	t <sub>H0</sub>		6	-	-	ns
	DCLK ↑ - LE	t <sub>H1</sub>		8	-	-	ns
	GCLK - LE ↑ (VSYNC)	t <sub>H2</sub>		300			ns
Propagation Delay Time	DCLK - SDO	t <sub>PD0</sub>		-	25	28	ns
	GCLK - OUT2n *	t <sub>PD1</sub>		-	35	-	ns
	LE - SDO	t <sub>PD2</sub> ***		-	30	40	ns
Staggered Delay of Output	OUT2n+1**	t <sub>DL1</sub>		-	5	-	ns
Pulse Width	LE	t <sub>w(LE)</sub>		15			ns
Command to Command		T <sub>CC</sub>		50	-	-	ns
Data Clock Frequency		F <sub>DCLK</sub>		-	-	30	MHz
Gray Scale Clock Frequency***		F <sub>GCLK</sub>		-	-	33	MHz
GCLK frequency (when GCLK multiplier is enabled)		F <sub>GCLK</sub>				16.6	MHz
Min Clock(GCLK/DCLK) Pulse Width****		t <sub>w(CLK)</sub>		12	-	-	ns
Ratio of (GCLK freq)/(DCLK freq)		R <sub>(GCLK/DCLK)</sub>		20	-	-	%
Compulsory Error Detection Operation time*****		t <sub>ERR-C</sub>		700	-	-	ns
Output Rise Time of Output Ports		t <sub>OR</sub>		-	15	25	ns
Output Fall Time of Output Ports		t <sub>OF</sub>	-	15	25	ns	
Dead Time		t <sub>dth</sub>	300			ns	
Dead Time (Low state)		t <sub>dtl</sub>	1200	-	-	ns	

\*Output waveforms have good uniformity among channels.

\*\* Refer to the Timing Waveform, where n=0, 1, 2, 3, 4, 5, 6, 7.

\*\*\*In timing of "configuration read", the next DCLK rising edge should be t<sub>PD2</sub> after LE's falling edge.

\*\*\*\*The Gray Scale Clock period must be 50% duty cycle when the function of GCLK multiplier is enabled.

\*\*\*\*\*Users have to leave more time than the maximum error detection time for the error detection.

for 1:32 Time-multiplexing Applications

**Switching Characteristics (V<sub>DD</sub>=3.3V, Ta=25°C)**

Characteristics		Symbol	Condition	Min.	Typ.	Max.	Unit
Setup Time	SDI - DCLK ↑	t <sub>SU0</sub>	V <sub>DD</sub> =3.3V V <sub>IH</sub> =V <sub>DD</sub> V <sub>IL</sub> =GND R <sub>ext</sub> =880Ω V <sub>DS</sub> =0.5V R <sub>L</sub> =300Ω C <sub>L</sub> =10pF C <sub>1</sub> =100nF C <sub>2</sub> =10μF C <sub>SDO</sub> =10pF V <sub>LED</sub> =4V ICG(Dec)=127 GCG (Dec)=8 *I <sub>OUT</sub> =10mA	7	-	-	ns
	LE - DCLK ↑	t <sub>SU1</sub>		10	-	-	ns
	LE ↓ (VSYNC) - GCLK	t <sub>SU2</sub>		1200	-	-	ns
	LE ↓ - DCLK ↑	t <sub>SU3</sub>		52	-	-	ns
Hold Time	DCLK ↑ - SDI	t <sub>H0</sub>		8	-	-	ns
	DCLK ↑ - LE	t <sub>H1</sub>		10	-	-	ns
	GCLK - LE ↓ (VSYNC)	t <sub>H2</sub>		300	-	-	ns
Propagation Delay Time	DCLK - SDO	t <sub>PD0</sub>		-	30	33	ns
	GCLK - OUT2n*	t <sub>PD1</sub>		-	45	-	ns
	LE - SDO	t <sub>PD2</sub> ***		-	40	50	ns
Staggered Delay of Output	OUT2n+1**	t <sub>DL1</sub>		-	8	-	ns
Pulse Width	LE	t <sub>w(LE)</sub>		16	-	-	ns
Command to Command		t <sub>CC</sub>		52	-	-	ns
Data Clock Frequency		F <sub>DCLK</sub>		-	-	25	MHz
Gray Scale Clock Frequency****		F <sub>GCLK</sub>		-	-	20	MHz
GCLK frequency (when GCLK multiplier is enabled)		F <sub>GCLK</sub>				10	MHz
Min Clock(GCLK/DCLK) Pulse Width****		t <sub>w(CLK)</sub>		13	-	-	ns
Ratio of (GCLK freq)/(DCLK freq)		R <sub>(GCLK/DCLK)</sub>		20	-	-	%
Compulsory Error Detection Operation time*****		t <sub>ERR-C</sub>		700	-	-	ns
Output Rise Time of Output Ports		t <sub>OR</sub>			25	35	ns
Output Fall Time of Output Ports		t <sub>OF</sub>		25	35	ns	
Dead Time		t <sub>dth</sub>	300	-	-	ns	
Dead Time (Low state)		t <sub>dtl</sub>	1200	-	-	ns	

\*Output waveforms have good uniformity among channels.

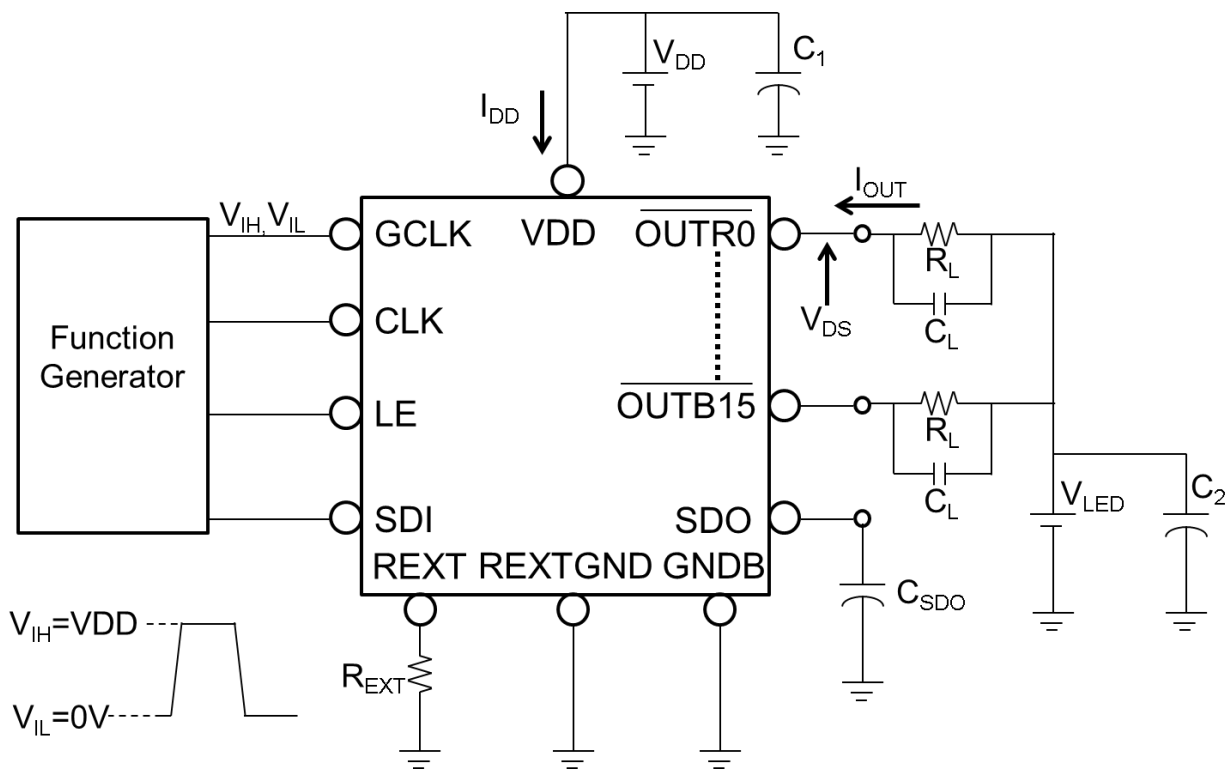
\*\* Refer to the Timing Waveform, where n=0, 1, 2, 3, 4, 5, 6, 7.

\*\*\*In timing of "configuration read", the next DCLK rising edge should be t<sub>PD2</sub> after LE's falling edge.

\*\*\*\*The Gray Scale Clock period must be 50% duty cycle when the function of GCLK multiplier is enabled.

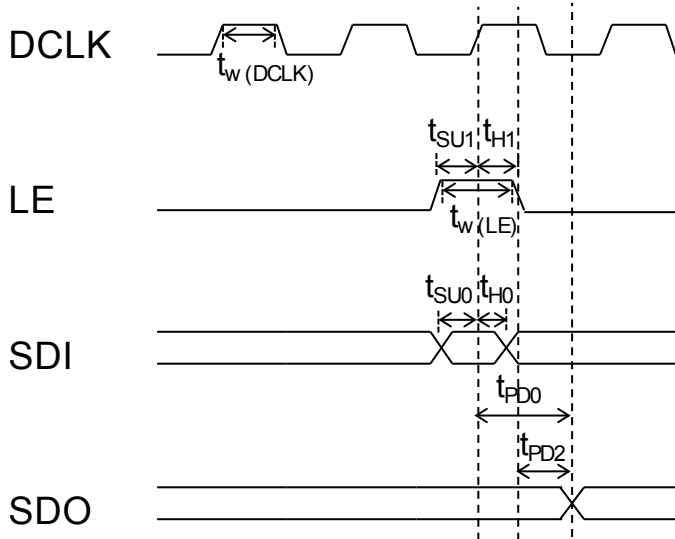
\*\*\*\*\*Users have to leave more time than the maximum error detection time for the error detection.

Test Circuit for Switching Characteristics

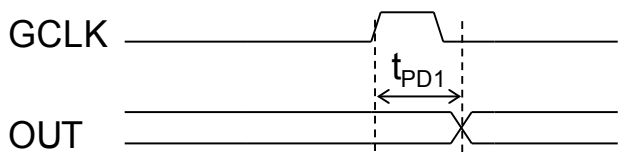


**Timing Waveform**

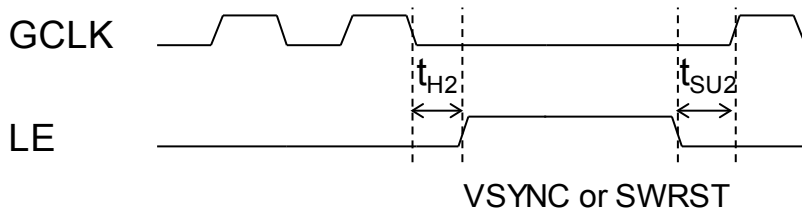
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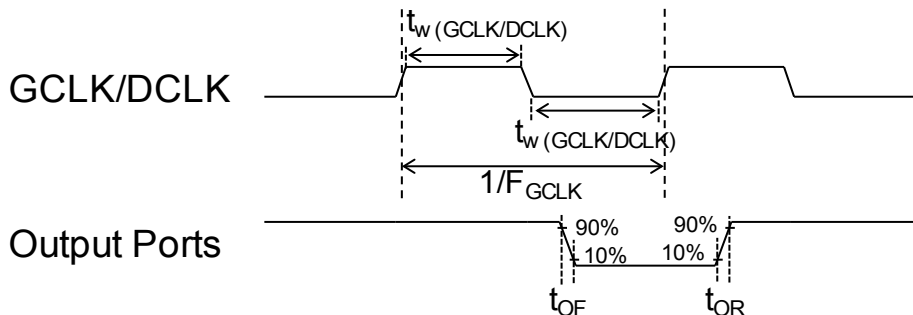
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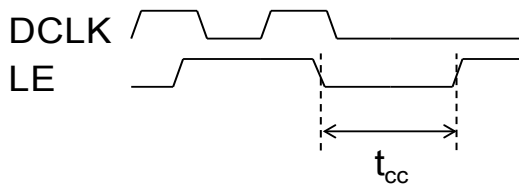
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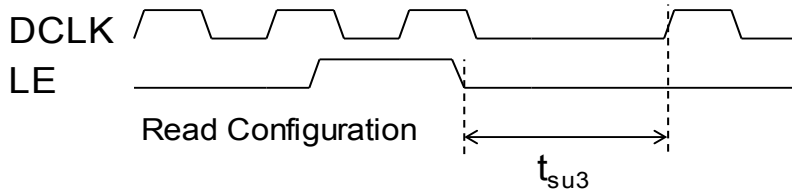
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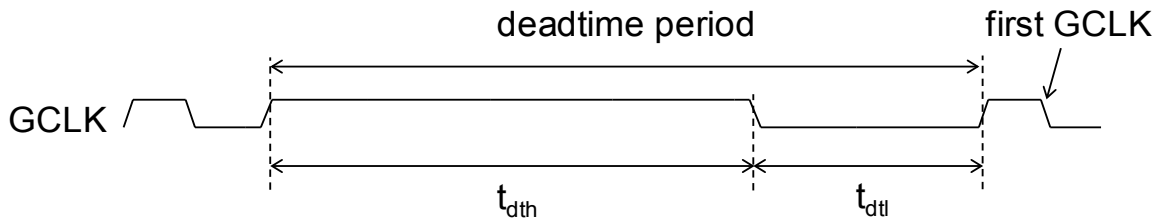
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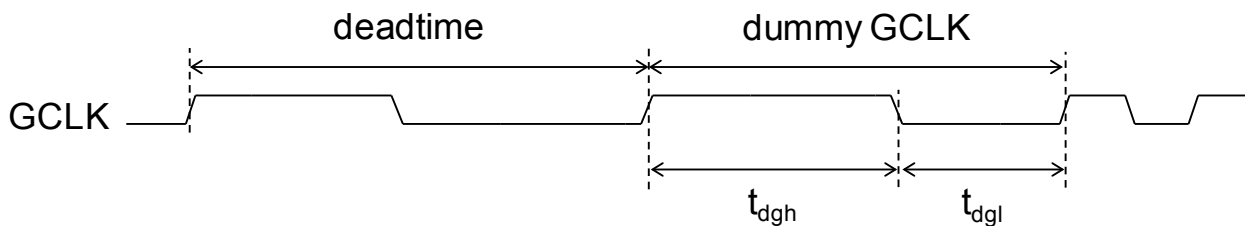
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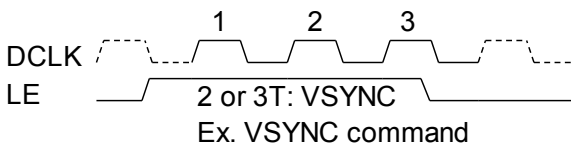
**Control Command**

Command Name	Signals Combination		Description
	LE	Number of DCLK Rising Edge when LE is asserted	Action of Command
Stop Compulsory Error detection	High	1	Stop compulsory LED open detection.
Data Latch	High	1	Serial data are transferred to the input data buffers.
VSYNC	High	2	Vertical Synchronal signal. Displaying frame will be updated to output channel.
Write Configuration 1*	High	4	Serial data are written to the global configuration register
Read Global Configuration	High	5	Serial data are read from the global configuration register
Read R Configuration	High	6	Serial data are read from the R configuration register
Read G Configuration	High	7	Serial data are read from the G configuration register
Read B Configuration	High	8	Serial data are read from the B configuration register
Start Compulsory Error Detection 1	High	9	Start compulsory LED open detection
SWRST	High	10	Reset the behavior of MBI5353 except the value of configuration registers.(software reset)
Start Compulsory Error Detection 2	High	13	Start compulsory LED short detection
Pre-Active	High	14	Pre-Active command needs to be sent before “Write Configuration” command.

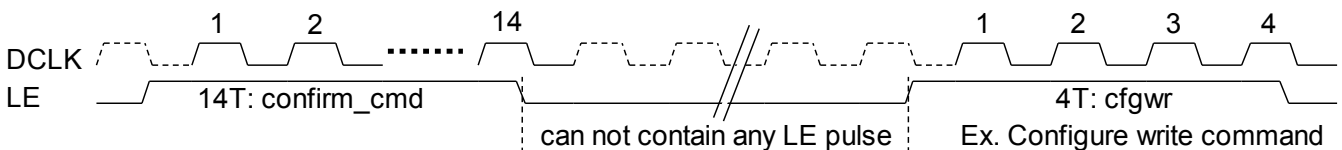
\*Those commands can only be activated after Pre-Active command; otherwise, they will be invalid.

**Note:** When the power is on, VSYNC command will be valid only after 16 times of “Data Latch” commands that have been sent in advance.

**Command which requires no pre-active command ahead**



**Command which requires pre-active command ahead**



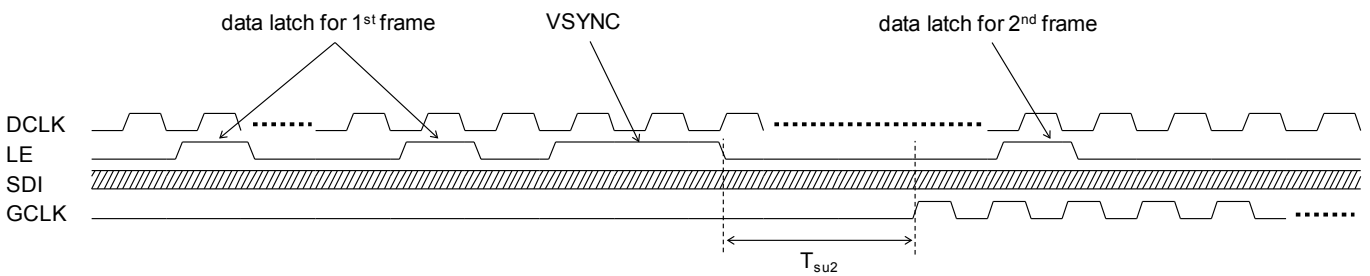
### Waveform of Commands

The following figures show the waveforms of each command.

#### Initialization Sequence

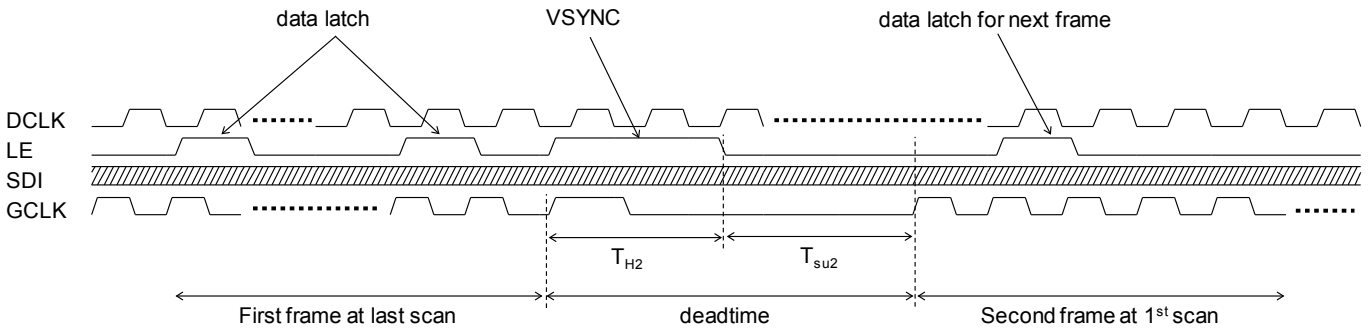
At initialization, users need to program the configuration register, if the default value of the register is not what they want. Then, the users need to send the gray scale data by the number of “Data Latch” commands (16 x number of scan lines), and then send one VSYNC command to start to display.

For the initial sequence, users should send VSYNC command after one frame “Data Latch” command as shown in the below waveform. The display data will not start until first VSYNC command is ready. The GCLK must be stopped before first VSYNC command is set



#### VSYNC Command Operation

“VSYNC” command is set when users want to update the image frame. Waveforms below derived how the VSYNC command updates the frame data.

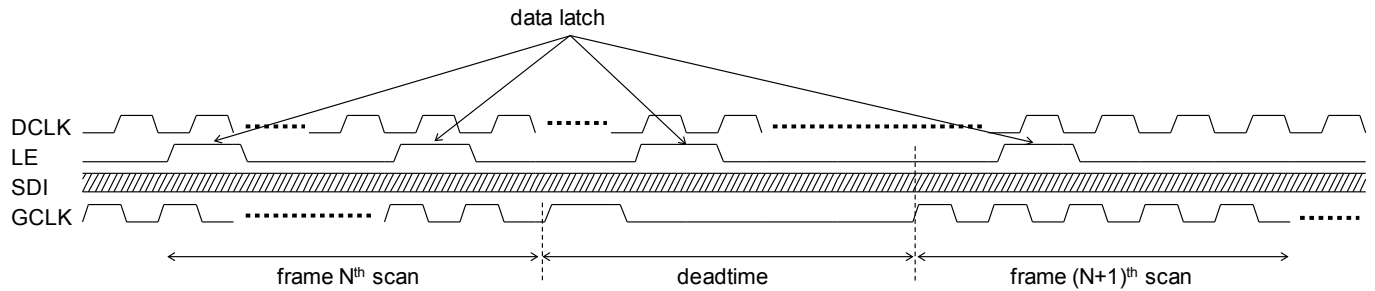


$T_{H2}$  is generated of delta and gclk extend function.



**Data latch Command Operation**

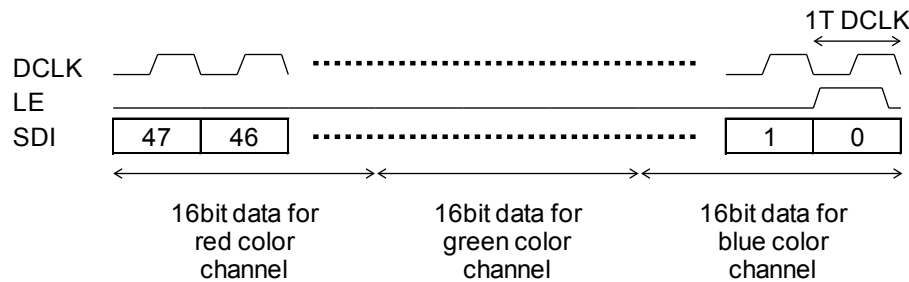
“data latch” command can be set during dead-time(when changing scan line)



There are limitations for users to follow:

- a.) It is suggested for controller to keep one GCLK counter (from 0~1024), which will preset to 1024 at the falling edge of LE of VSYNC command and restart from 0 at next GCLK.
- b.) Since VSYNC is the LE clock domain, there is a timing limitation between LE and GCLK. The GCLK should stop before VSYNC command is sent. The setup and hold time between LE’s falling edge and GCLK’s rising edge must meet the  $T_{SU2}$  and  $T_{H2}$ , respectively.(The period of  $T_{H2}$  must greater than 300 ns and  $T_{SU2}$  must greater than 1200ns.)
- c.) The GCLK also needs to stop for dead time. The dead time is the time interval between scan lines, and is controlled by stopping GCLK. When VSYNC command is set, the frame will be updated. The scan line needs to be switched (by controller) from scan line k to scan line 0, too.
- d.) DCLK can either stop or not when there is no command.
- e.) The new data will be loaded to internal display buffer at VSYNC command. But it will start to display after dead time is finished.

**Data Latch**

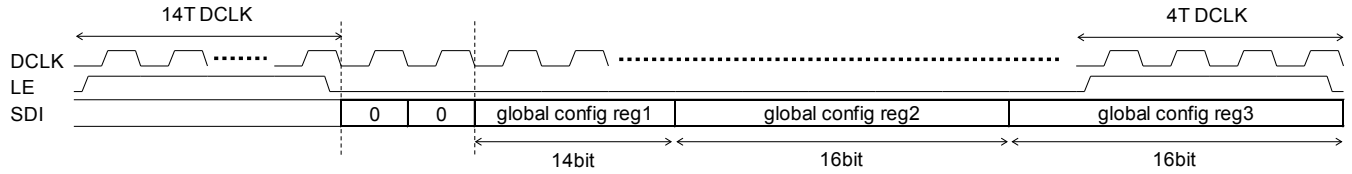


Data Latch command is used to latch the 48-bit shift register from SDI to internal SRAM buffer. When this command is received, the last 48 bits data before the falling edge of LE will be latched into SRAM, as shown in the above waveform, and MSB bit needs to be sent first.

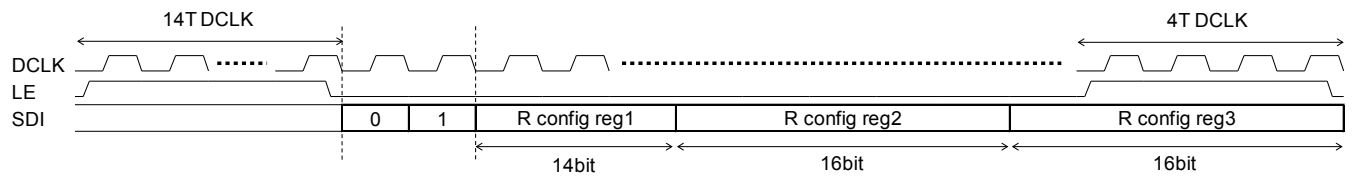
**Write Configuration**

“Write configuration” command is used to program the configuration register of MBI5353. The “Pre-Active” command must be sent in advance. When this command is received, the last 48 bits data before the falling edge of LE will be latched into configuration register, as shown in the above waveform, and MSB bit needs to be sent first.

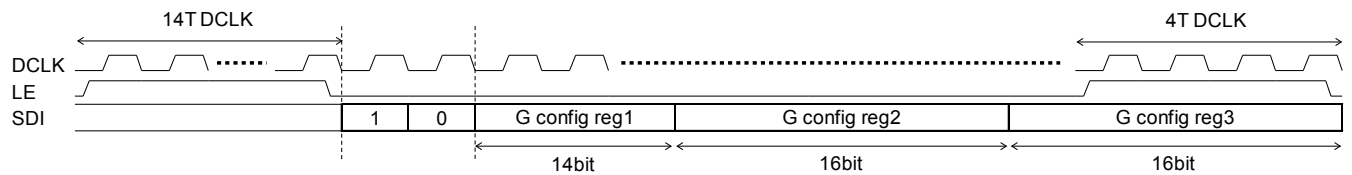
**Write global configuration register**



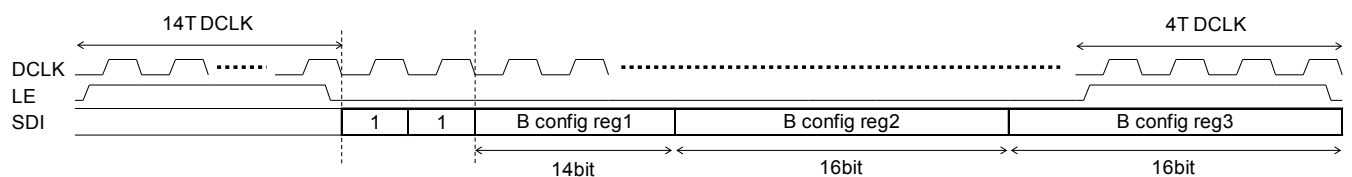
**Write red color configuration register**



**Write green color configuration register**



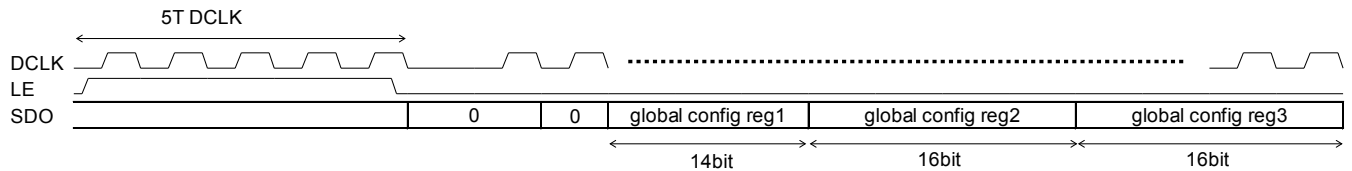
**Write blue color configuration register**



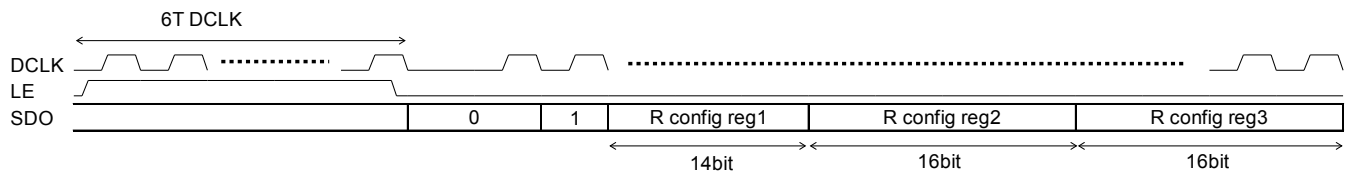
**Read Configuration**

“Read configuration” command is used to read the configuration register of MBI5353. When this command is received, the 48-bit data of configuration register will be shifted out from SDO pin, as shown in the above waveform, and MSB bit will be shifted out first.

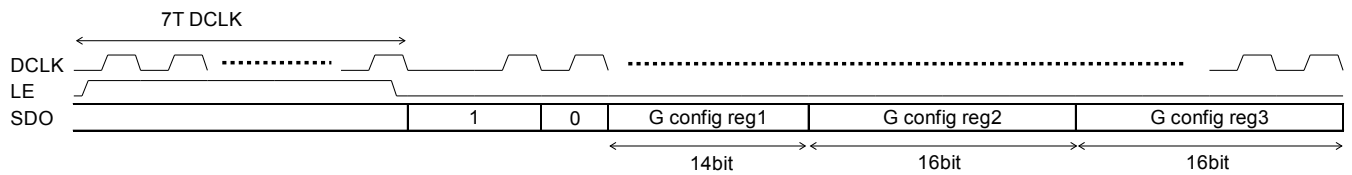
**Read global configuration register**



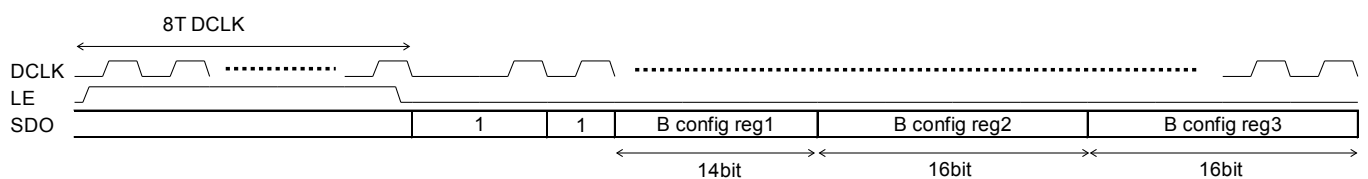
**Read red configuration register**



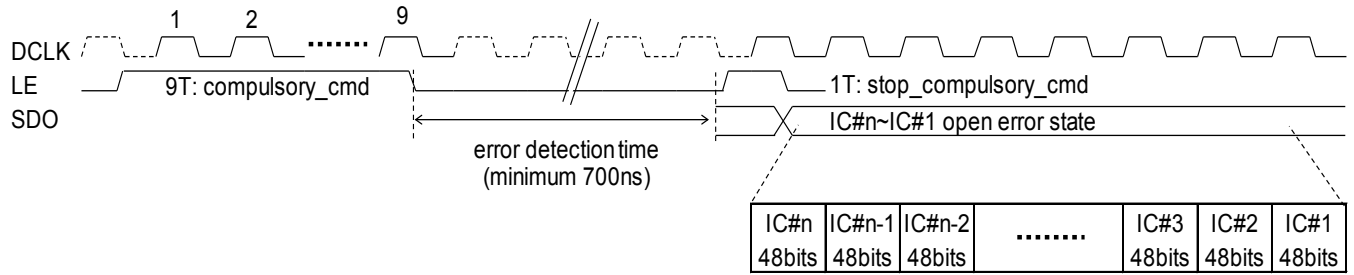
**Read green configuration register**



**Read blue configuration register**

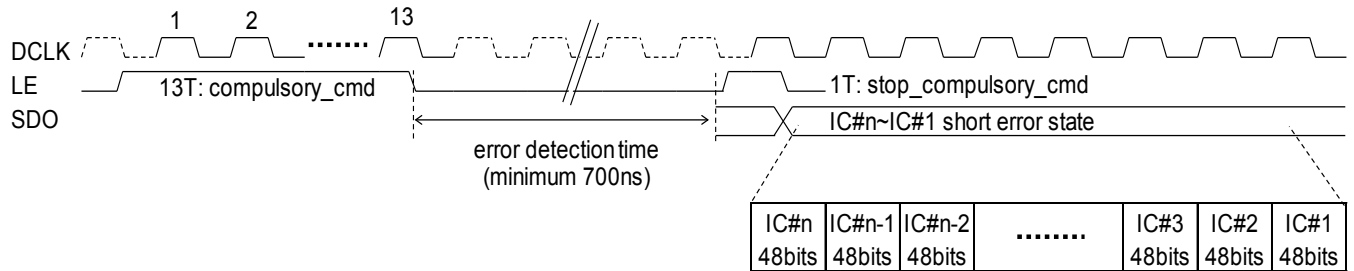


**Compulsory LED open detection**



IC#n 48bits are composed of { $\overline{\text{OUTR15}}$ ,  $\overline{\text{OUTG15}}$ ,  $\overline{\text{OUTB15}}$ ,  $\overline{\text{OUTR14}}$ ,  $\overline{\text{OUTG14}}$ ,  $\overline{\text{OUTB14}}$ , ...,  $\overline{\text{OUTR0}}$ ,  $\overline{\text{OUTG0}}$ ,  $\overline{\text{OUTB0}}$ }.

**Compulsory LED short detection**



IC#n 48bits are composed of { $\overline{\text{OUTR15}}$ ,  $\overline{\text{OUTG15}}$ ,  $\overline{\text{OUTB15}}$ ,  $\overline{\text{OUTR14}}$ ,  $\overline{\text{OUTG14}}$ ,  $\overline{\text{OUTB14}}$ , ...,  $\overline{\text{OUTR0}}$ ,  $\overline{\text{OUTG0}}$ ,  $\overline{\text{OUTB0}}$ }.

**SWRST Command Operation**

“SWRST” command makes MBI5353 go back to the initial state except configuration register value. After this command is received, the output channels will be turned off and will display again with last gray-scale value after new “VSYNC” command is received.

for 1:32 Time-multiplexing Applications

**Definition of Global Configuration Register 1**

MSB

LSB

D	C	B	A	9	8	7	6	5	4	3	2	1	0
---	---	---	---	---	---	---	---	---	---	---	---	---	---

e.g. Default Value

D	C	B	A	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	1	1	0	0	0	0	0

Default setting of configuration register is 16'h032B

Bit	Attribute	Definition	Value	Function
D~C	Read/Write	Grayscale mode select	00 (Default)	Grayscale PWM is 16bit mode, each PWM cycle is 65536 GCLKs
			01	Grayscale PWM is 15bit mode, each PWM cycle is 32768 GCLKs User should still send 16bit data with 1 bit 0 in LSB bits. Ex., {15'h1234, 1'h0}.
			10	Grayscale PWM is 14bit mode, each PWM cycle is 16384 GCLKs User should still send 16bit data with 2 bit 0 in LSB bits. Ex., {14'h1234, 2'h0}.
			11	Grayscale PWM is 13bit mode, each PWM cycle is 8192 GCLKs User should still send 16bit data with 3 bit 0 in LSB bits. Ex., {13'h1234, 3'h0}.
B~A	Read/Write	S-PWM mode	00 (Default)	If grayscale PWM 16bit mode is asserted, PWM cycle is divided into 64 sections If grayscale PWM 15bit mode is asserted, PWM cycle is divided into 32 sections If grayscale PWM 14bit mode is asserted, PWM cycle is divided into 16 sections If grayscale PWM 13bit mode is asserted, PWM cycle is divided into 8 sections, each section has 1024 GCLKs.
			01	If grayscale PWM 16bit mode is asserted, PWM cycle is divided into 128 sections If grayscale PWM 15bit mode is asserted, PWM cycle is divided into 64 sections If grayscale PWM 14bit mode is asserted, PWM cycle is divided into 32 sections If grayscale PWM 13bit mode is asserted, PWM cycle is divided into 16 sections, each section has 512 GCLKs.
			10	If grayscale PWM 16bit mode is asserted, PWM cycle is divided into 256 sections If grayscale PWM 15bit mode is asserted, PWM cycle is divided into 128 sections If grayscale PWM 14bit mode is asserted, PWM cycle is divided into 64 sections If grayscale PWM 13bit mode is asserted, PWM cycle is divided into 32 sections, each section has 256 GCLKs.
			11	If grayscale PWM 16bit mode is asserted, PWM cycle is divided into 512 sections If grayscale PWM 15bit mode is asserted, PWM cycle is divided into 256 sections If grayscale PWM 14bit mode is asserted, PWM cycle is divided into 128 sections If grayscale PWM 13bit mode is asserted, PWM cycle is divided into 64 sections, each section has 128 GCLKs.

for 1:32 Time-multiplexing Applications

9~5	Read/Write	Number of scan lines	00000 00001 00010 00011 (Default) ~ 11111	00000: 1 lines; 01000: 9 lines; 10000: 17 lines; 00001: 2 lines; 01001: 10 lines; 10001: 18 lines; 00010: 3 lines; 01010: 11 lines; 10010: 19 lines; 00011: 4 lines; 01011: 12 lines; . 00100: 5 lines; 01100: 13 lines; . 00101: 6 lines; 01101: 14 lines; . 00110: 7 lines; 01110: 15 lines; . 00111: 8 lines; 01111: 16 lines; 11111: 32 lines;
4	Read/Write	GCLK multiplier	0 (Default)	GCLK multiplier disable
			1	GCLK multiplier enable
3~0	Read/Write	Reserved	0000 (Default)	Reserved

**Default setting of configuration register is 16'h0060**

**Definition of Global Configuration Register 2**

MSB														LSB	
F	E	D	C	B	A	9	8	7	6	5	4	3	2	1	0

e.g. Default Value

F	E	D	C	B	A	9	8	7	6	5	4	3	2	1	0
0	0	0	0	1	1	1	0	0	0	0	0	0	0	0	0

Bit	Attribute	Definition	Value	Function
F~C	Read/Write	Reserved	0000 (default)	Reserved
B	Read/Write	R <sub>EXT</sub> short detection enable	0 1 (Default)	R <sub>EXT</sub> short detection enable
A~9	Read/Write	Global current gain (Constant gain ) *	00~ 11(default)	00: Reserved 01: Current ratio=15.8* 10: Reserved 11: Current ratio=47.6*
8~6	Read/Write	Global current gain (Adjustable gain ) *	000 (default) ~ 111	000~111: Current ratio=100%~200% 1step=14%
5	Read/Write	Reserved	0 (Default)	Reserved
4~3	Read/Write	Stagger delay	00 (Default)	No stagger
			01~11	Stagger delay enable 01: Red color group lead Green color group 25ns Green color group lead Blue color group 25ns 10: Red color group lead Green color group 50ns Green color group lead Blue color group 50ns 11: Red color group lead Green color group 75ns Green color group lead Blue color group 75ns
2~0	Read/Write	Reserved	000 (default)	Reserved

**Default setting of configuration register is 16'h0e00**

\* Refer to "Setting Output Current" section

**Definition of R/G/B Individual Configuration Register 1**

MSB

LSB

F	E	D	C	B	A	9	8	7	6	5	4	3	2	1	0
---	---	---	---	---	---	---	---	---	---	---	---	---	---	---	---

e.g. Default Value

		D	C	B	A	9	8	7	6	5	4	3	2	1	0
		0	0	0	0	1	1	1	1	1	1	1	1	1	1

Bit	Attribute	Definition	Value	Function
D~A	Read	Reserved	0000	0000
9	Read/Write	Reserved	1(default)	Reserved
8~2	Read/Write	Current gain adjustment*	0000000~1111111	7'b1111111 (Default) Allow 128-step programmable current gain, and the gain range is from 200%-1.6%.
1~0	Read/Write	Reserved**	11(default)	Reserved

**Default setting of configuration register is 16'h03FF**

\* Refer to "Setting Output Current" section

\*\* Please assign "00" as a suggested value



for 1:32 Time-multiplexing Applications

**Gray Scale Mode and Scan-type S-PWM**

MBI5353 provides a selectable 16 / 15 / 14 / 13-bit gray scale by setting the global configuration register1 bit [D:C] and [B:A], the default value is set to '00' and '00', so the grayscale PWM is asserted as 16-bit mode, PWM cycle is divided into 64 sections.

MBI5353 has a smart S-PWM technology for scan type. With S-PWM, the total PWM cycles can be divided into MSB (Most Significant Bits) and LSB (Least Significant Bits) of gray scale cycles. The MSB information can be broken down into many refresh cycles to achieve overall same high bit resolution.

**Number of Scan Line**

MBI5353 supports 1 to 32 scan lines. Please set the global configuration register1 bit [9:5] according to the application. The default value '00011' is 4 scan lines.

**Data Input Sequence**

The sequence of input data starts from scan line 0 first, and then scan line 1 ,and so on.

During each scan line, grayscale data of  $\overline{\text{OUTR15}}/\overline{\text{OUTG15}}/\overline{\text{OUTB15}}$  needs to be sent first, and then  $\overline{\text{OUTR14}}/\overline{\text{OUTG14}}/\overline{\text{OUTB14}}$ , continuously to channel  $\overline{\text{OUTR0}}/\overline{\text{OUTG0}}/\overline{\text{OUTB0}}$ .

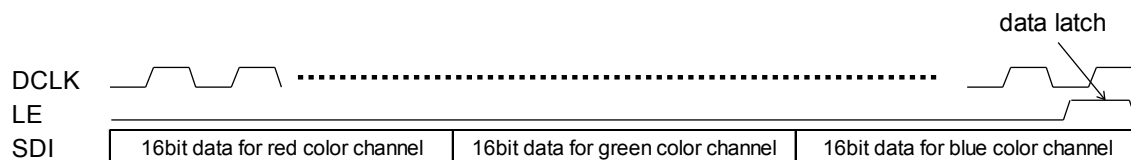
Please refer to the section of scan type application structure for scan type scheme.

The following examples are the waveforms with 1 LED driver and 2 cascaded LED drivers respectively.

For one channel, at 14-bit mode, the MSB 14 bits are valid, the other LSB bits are invalid. The data format is as following:

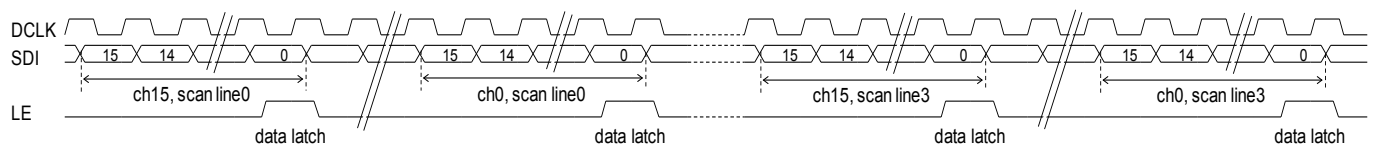
15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
----	----	----	----	----	----	---	---	---	---	---	---	---	---	---	---

Each data latch includes one pixel gray data, that is  $\overline{\text{OUTR\#}}/\overline{\text{OUTG\#}}/\overline{\text{OUTB\#}}$  gray data,  $\# = 15 \sim 0$ .



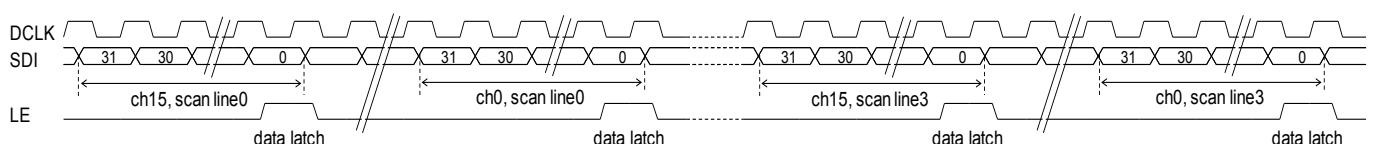
**1x IC, 4 scan lines**

For only one LED driver used, there are 48 bits for each pixel, and note that MSB bit is sent first.



**2x ICs, 4 scan lines**

For two LED drivers cascaded, there are 48 bits for each LED driver, so there are 96 bits for each pixel, first 48 bits (bit95 ~ bit48) is for 2<sup>nd</sup> LED driver, and last 48 bits (bit47 ~ bit0) is for 1<sup>st</sup> LED driver, please note that MSB bit is sent first, too.



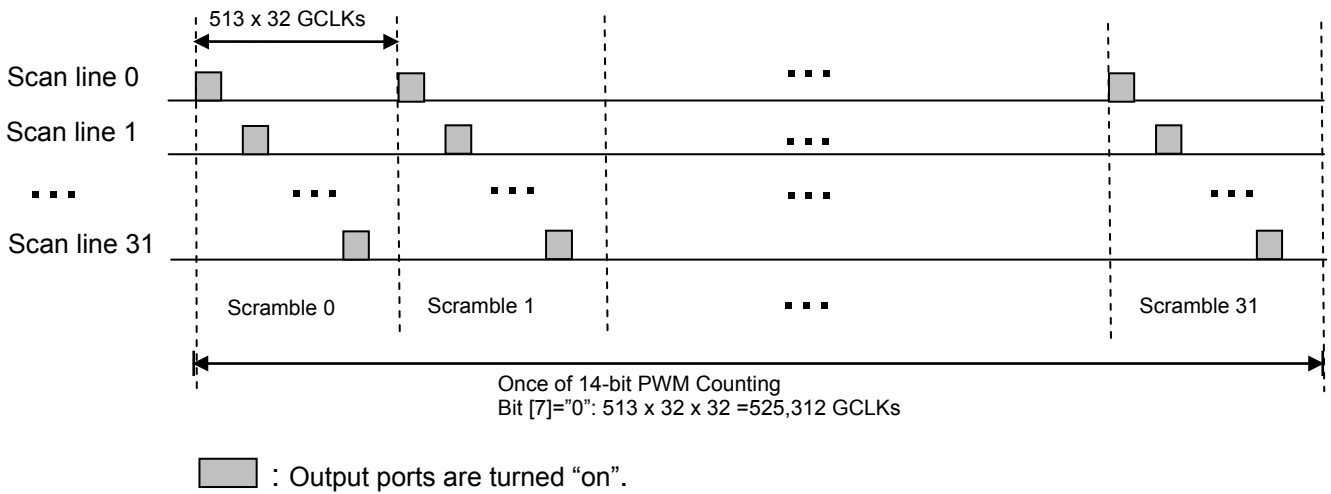
**GCLK multiplier**

MBI5353 provides a GCLK multiplier function by setting the global configuration register1 bit [4]. The default value is set to '0' for GCLK multiplier disabled.

GCLK multiplier disabled (global configuration register1 bit [4] = 0), take grayscale PWM 14-bit mode. PWM cycle is divided into 32 sections as an example,

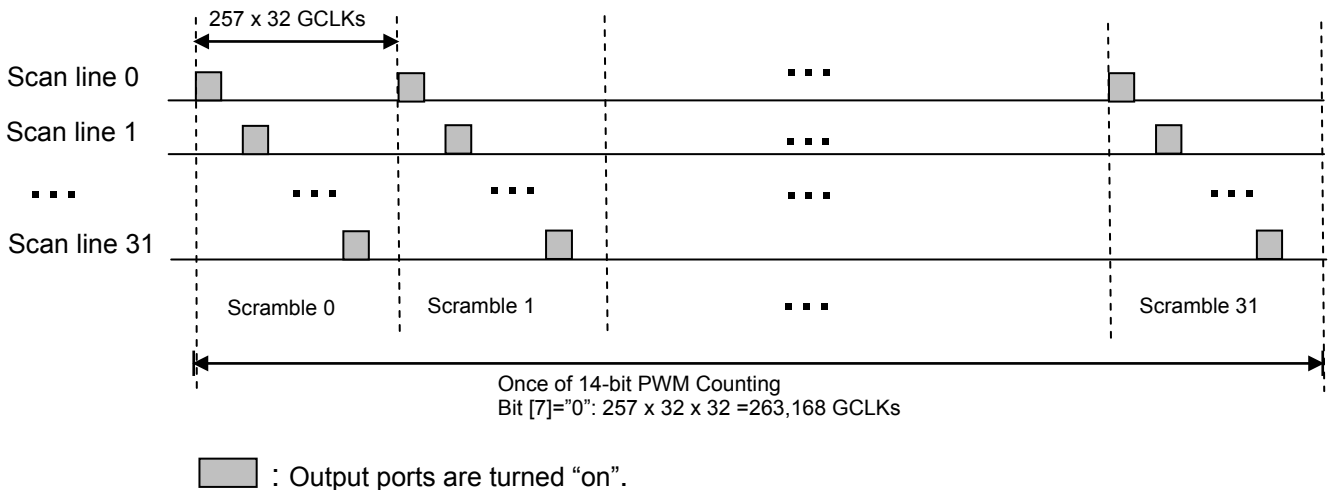
**GCLK multiplier disabled (configuration register1 bit [6] = 0)**

Display sequence of 32 scrambles



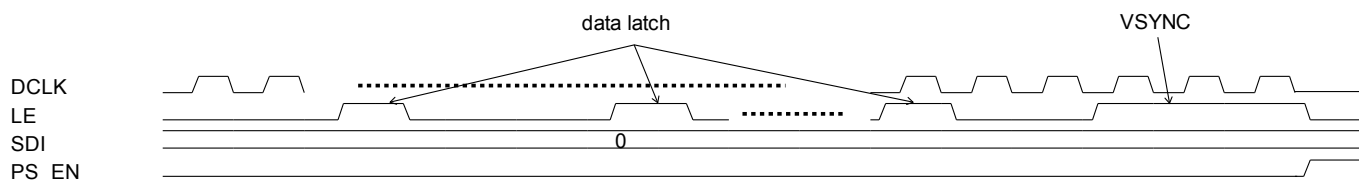
**GCLK multiplier enabled (configuration register1 bit [6] = 1)**

Display sequence of 32 scrambles

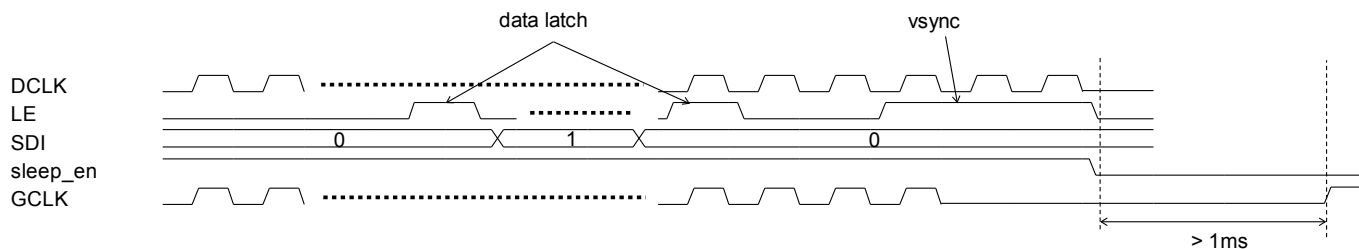


**Power saving mode**

If all grayscale data of one frame are all zero, then MBI5353 will enter power saving mode after VSYNC.

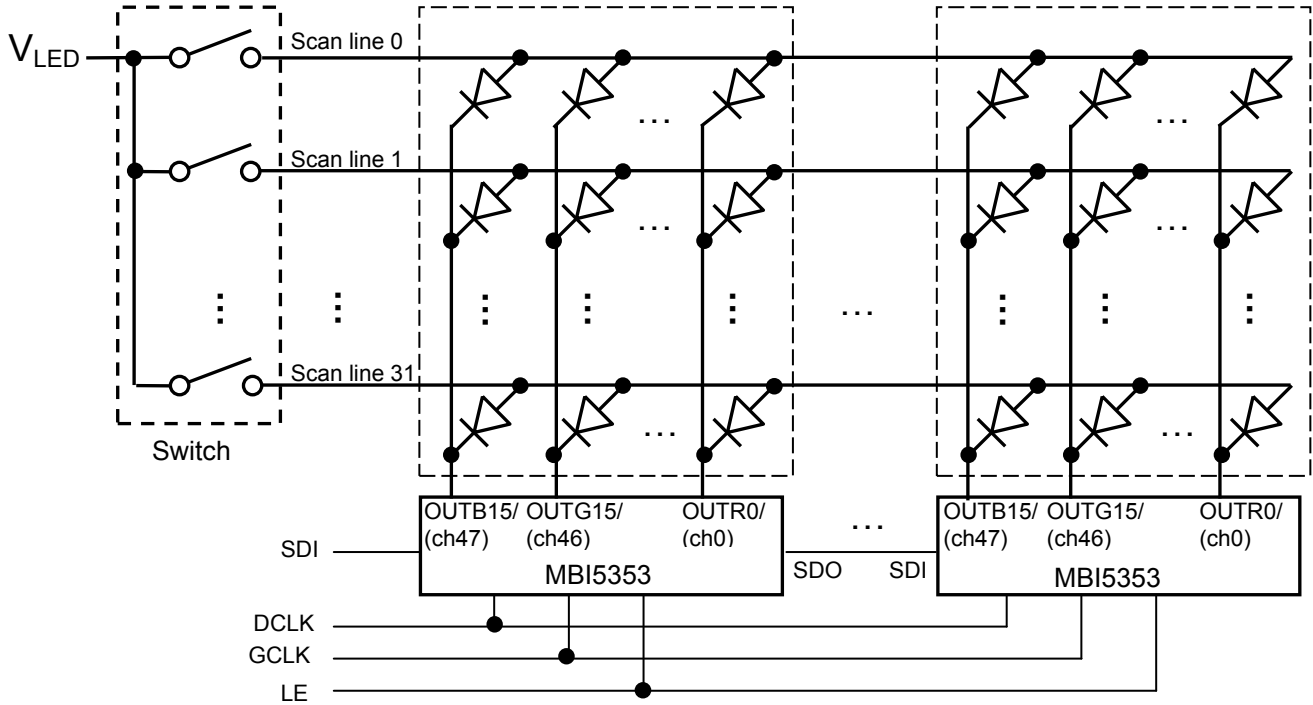


If any grayscale data of one frame is non-zero, then MBI5353 will leave power saving mode after VSYNC. To be noticed, the suggested time length to back to normal operation of MBI5353 is over 1ms.



### Operation Principle

#### Scan type application structure

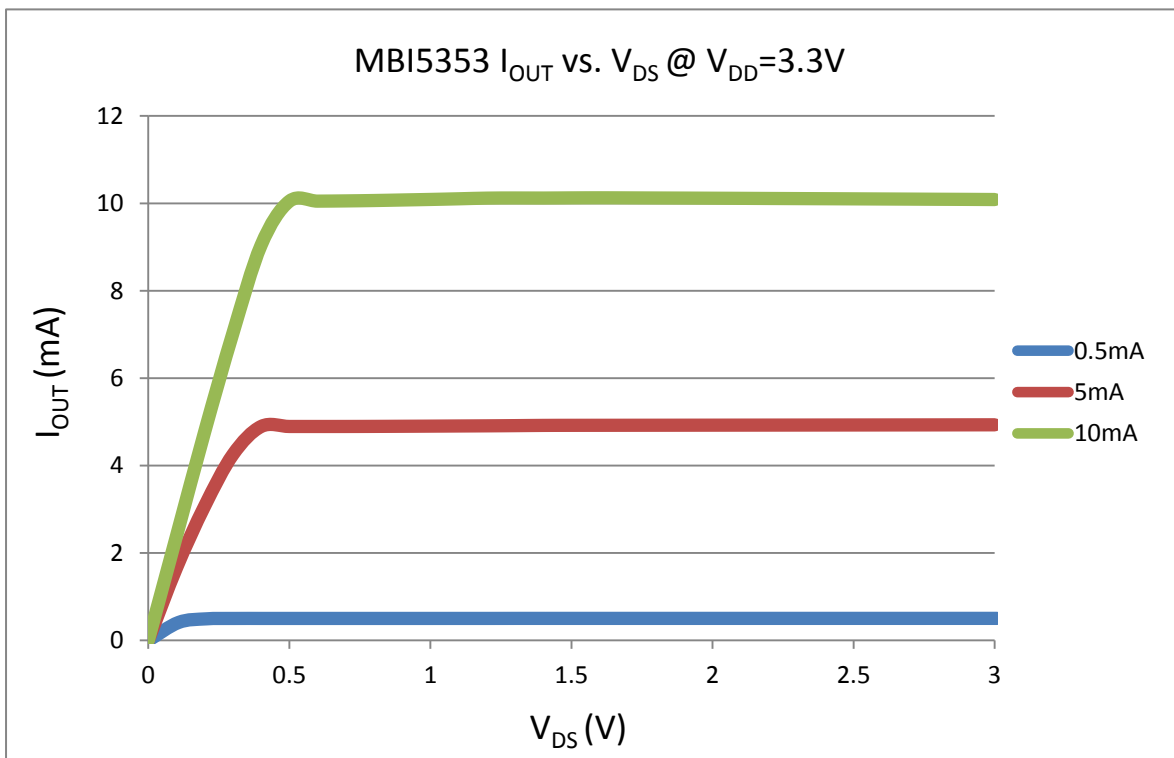
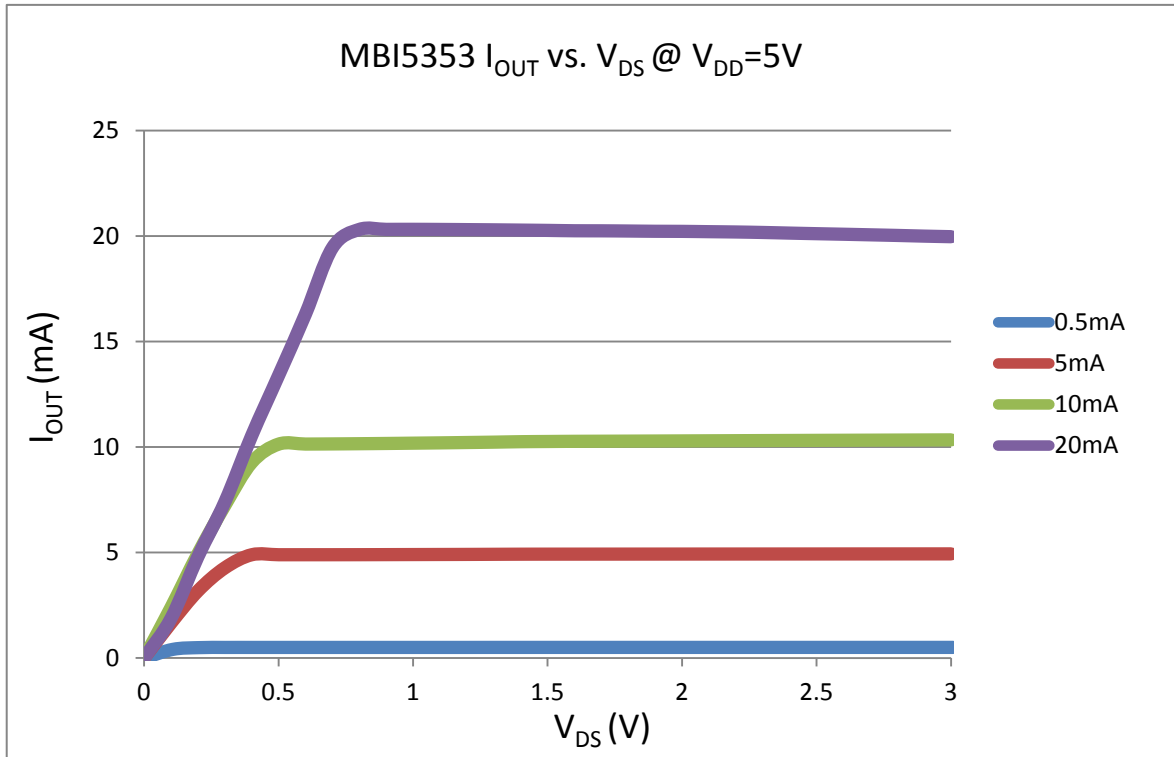


The above figure shows the suggested application structure of scan type scheme with 32 scan lines. The gray-scale data are sent by pin “SDI and SDO” with the commands formed by pin “LE” and “DCLK”. The output ports from 48 channels ( $\overline{OUTR15}/\overline{OUTG15}/\overline{OUTB15}$ , ...,  $\overline{OUTR0}/\overline{OUTG0}/\overline{OUTB0}$ ) will output the PWM result for each scan line at different time, so there must be one “Switch” to multiplex for each scan line. The switching sequence and method and the command usage will be described in the application note.

**Constant Current**

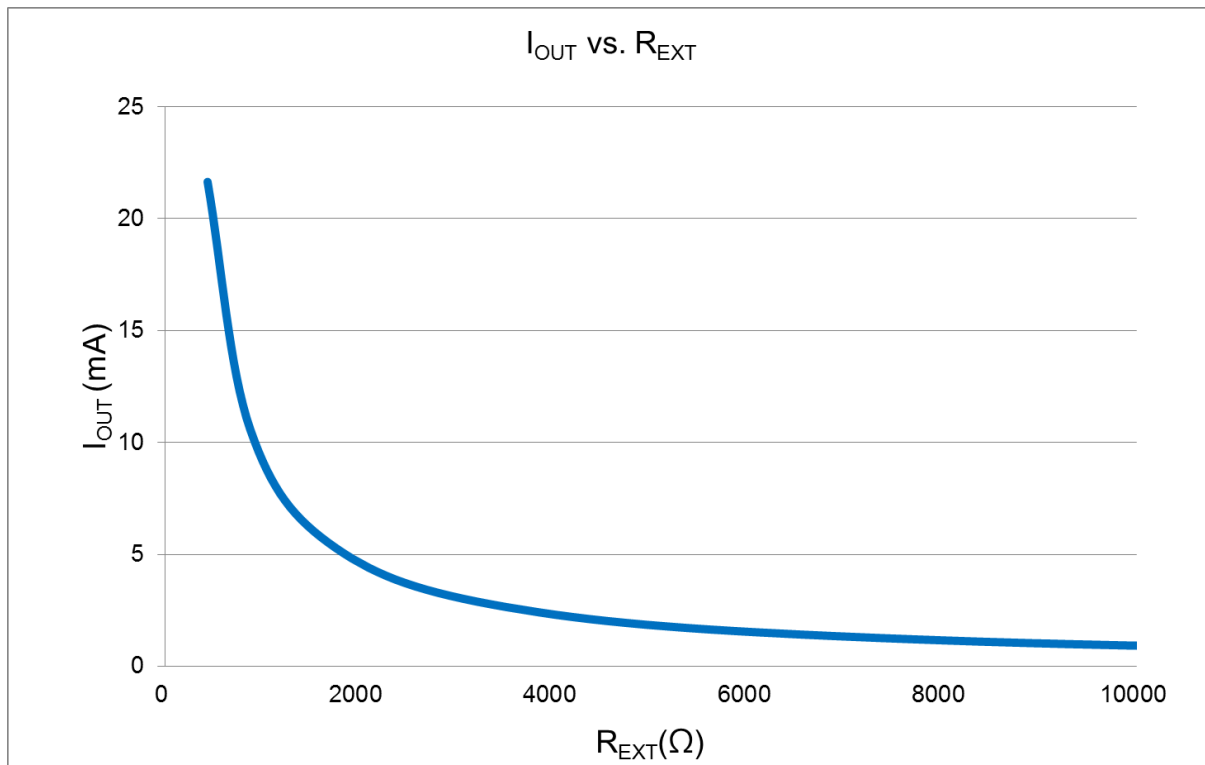
In LED display application, MBI5353 provides nearly no variation in current from channel to channel and from IC to IC. This can be achieved by:

- 1) The maximum current variation between channels is less than 2.5%, and that between ICs is less than ±3%
- 2) In addition, the current characteristic of output stage is flat and user can refer to the figure below. The output current can be kept constant regardless of the variations of LED forward voltages ( $V_F$ ). This guarantees LED to be performed on the same brightness as user’s specification.



### Setting Output Current

The output current ( $I_{OUT}$ ) is set by an external resistor,  $R_{EXT}$ . The default relationship between  $I_{OUT}$  and  $R_{EXT}$  is shown in the following figure.



Users can follow the below formulas to calculate the target output current  $I_{OUT}$ .

$$I_{OUT, GCG} = \frac{1}{R_{EXT}} * 0.600$$

Whereas  $R_{EXT}$  is the resistance of the external resistor connected to  $R_{EXT}$  terminal and ground.

For your information, the output current is about 10mA when  $R_{EXT}=880\Omega$ . To apply current gain for output current adjustment, please refer to the next section “Current Gain Adjustment”.

## Current Gain Adjustment

### Global Current Gain Adjustment

GCG(Global Current Gain) is in global configuration register 2, and GCG[A:9] is set by global configuration register 2[A:9], similarly, GCG[8:6] is set by global configuration register 2[8:6]; Gain1 and Gain2 are the digital current gain, which is set by GCG[A:9] and GCG[8:6]. (The default value of GCG[A:6]=8(dec), which means Gain1=47.6 and Gain2=1). When global current gain adjustment is applied, users can follow the formulas below to calculate the target output current,  $I_{OUT, GCG}$ ,

$$I_{OUT, GCG} = \frac{1}{R_{EXT}} * 0.600 * Gain1 * Gain2 ;$$

$$Gain1 = (GCG[A:9])$$

$$Gain2 = \left( \frac{GCG[8:6]}{6.944} + 1 \right)$$

For your information, the output current is about 10mA when  $R_{EXT}=880\Omega$  if Gain1 and Gain2 is set to default value. The formula and the setting for Gain1, Gain2 are described below.

Global Configuration Register 2

F	E	D	C	B	A	9	8	7	6	5	4	3	2	1	0
-	-	-	-	-	GCG4	GCG3	GCG2	GCG1	GCG0	-	-	-	-	-	-

Bit A to 9 is a coarse adjustment current gain.

GCG[A:9]-Code	[01]	[11]*
Gain2	15.875	47.625

\* Default GCG[A:9]=[11]

Bit 8 to 6 is Fine adjustment Current Gain.

GCG[8:6] -Code	[000]*	[001]	[010]	[011]	[100]	[101]	[110]	[111]
Gain1	1.000	1.144	1.288	1.432	1.576	1.720	1.864	2.008

\* Default GCG[8:6]=[000]

### R/G/B Individual Current Gain Adjustment

Definition of R/G/B Individual Configuration Register 1

F	E	D	C	B	A	9	8	7	6	5	4	3	2	1	0
-	-	0	0	0	0	ICG7	ICG6	ICG5	ICG4	ICG3	ICG2	ICG1	ICG0	0	0

When R/G/B individual current gain adjustment is applied, users can follow the below formulas to calculate the target output current  $I_{OUT, ICG}$ ,

$$I_{OUT, ICG} = I_{OUT, GCG} * \frac{Code}{127}$$

, where the smallest Code is 1.

The output current of R/G/B can be adjusted with individual current gain by 127 steps.

**Package Power Dissipation (PD)**

The maximum allowable package power dissipation is determined as  $P_D(max)=(T_j-T_a)/R_{th(j-a)}$ . When 16 output channels are turned on simultaneously, the actual package power dissipation is

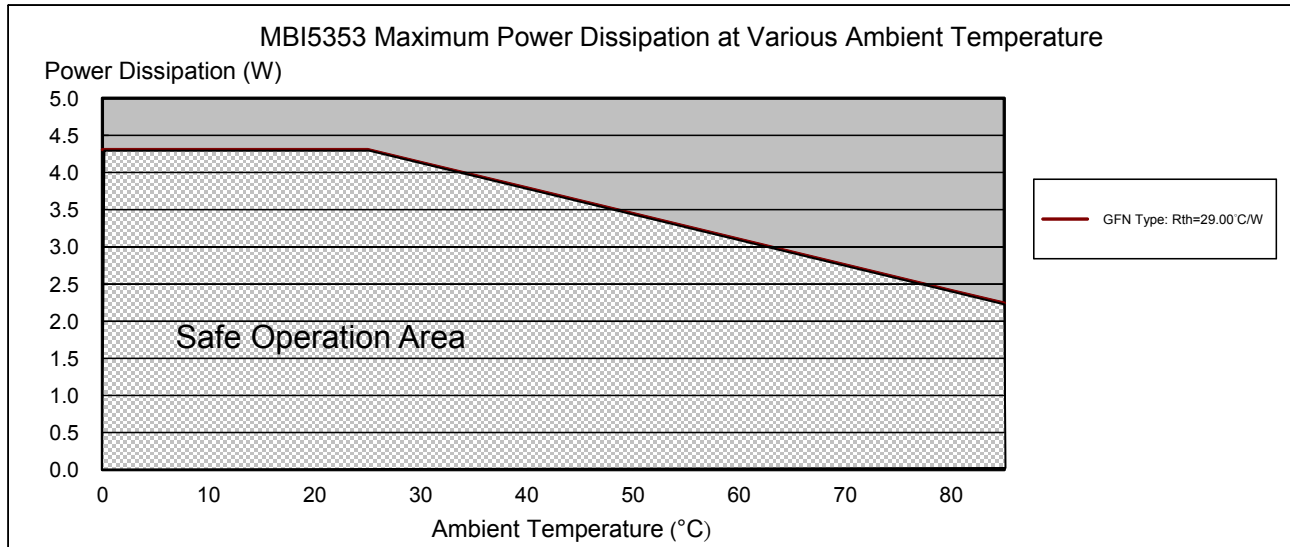
$P_D(act)=(I_{DD} \times V_{DD})+(I_{OUT} \times Duty \times V_{DS} \times 16)$ . Therefore, to keep  $P_D(act) \leq P_D(max)$ , the allowable maximum output current as a function of duty cycle is:

$$I_{OUT} = \{[(T_j - T_a) / R_{th(j-a)}] - (I_{DD} \times V_{DD})\} / V_{DS} / Duty / 16, \text{ where } T_j = 150^\circ\text{C}.$$

Please see the follow table for  $P_D$  and  $R_{th(j-a)}$  for different packages:

Device Type	$R_{th(j-a)}$ ( $^\circ\text{C/W}$ )	$P_D$ (W)
GFN	29	3.45

The maximum power dissipation,  $P_D(max)=(T_j-T_a)/R_{th(j-a)}$ , decreases as the ambient temperature increases.



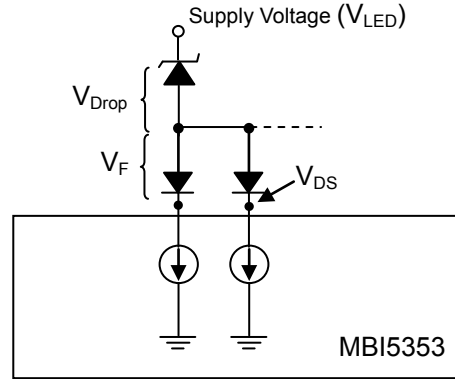
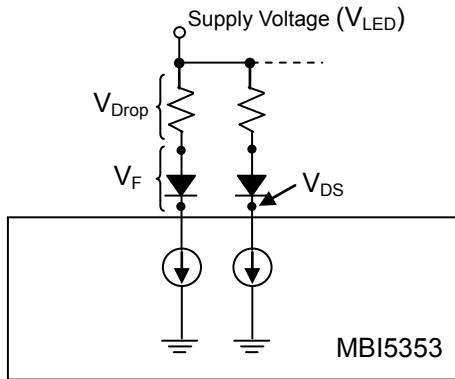


**LED Supply Voltage ( $V_{LED}$ )**

MBI5353 is designed to operate with  $V_{DS}$  ranging from 0.4V to 1.0V (depending on  $I_{OUT}=0.5\sim 20mA$ ) considering the package power dissipating limits.  $V_{DS}$  may be higher enough to make  $P_{D( act )} > P_{D( max )}$  when  $V_{LED}=5V$  and  $V_{DS}=V_{LED}-V_F$ , in which  $V_{LED}$  is the load supply voltage. In this case, it is recommended to use the lowest possible supply voltage or to set an external voltage reducer,  $V_{DROP}$ .

A voltage reducer lets  $V_{DS}=(V_{LED}-V_F)-V_{DROP}$ .

Resistors or Zener diode can be used in the applications as shown in the following figures.



**Switching Noise Reduction**

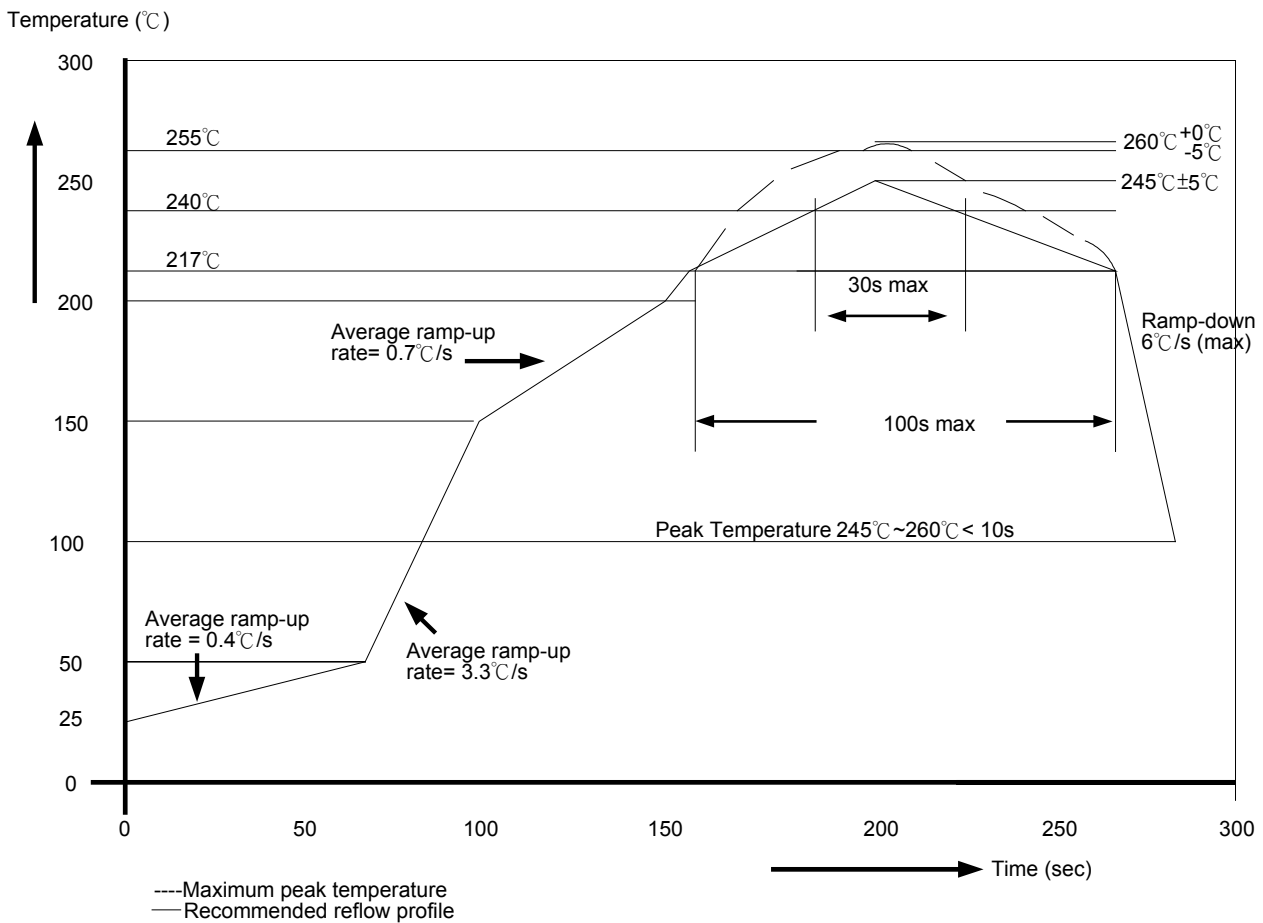
LED drivers are frequently used in switch-mode applications which always behave with switching noise due to the parasitic inductance on PCB. To eliminate switching noise, refer to “Application Note for 8-bit and 16-bit LED Drivers- Overshoot”.

for 1:32 Time-multiplexing Applications

**Soldering Process of “Pb-free & Green” Package Plating\***

Macroblock has defined "Pb-Free & Green" to mean semiconductor products that are compatible with the current RoHS requirements and selected 100% pure tin (Sn) to provide forward and backward compatibility with both the current industry-standard SnPb-based soldering processes and higher-temperature Pb-free processes. Pure tin is widely accepted by customers and suppliers of electronic devices in Europe, Asia and the US as the lead-free surface finish of choice to replace tin-lead. Also, it adopts tin/lead (SnPb) solder paste, and please refer to the JEDEC J-STD-020C for the temperature of solder bath. However, in the whole Pb-free soldering processes and materials, 100% pure tin (Sn) will all require from 245 °C to 260 °C for proper soldering on boards, referring to JEDEC J-STD-020C as shown below.

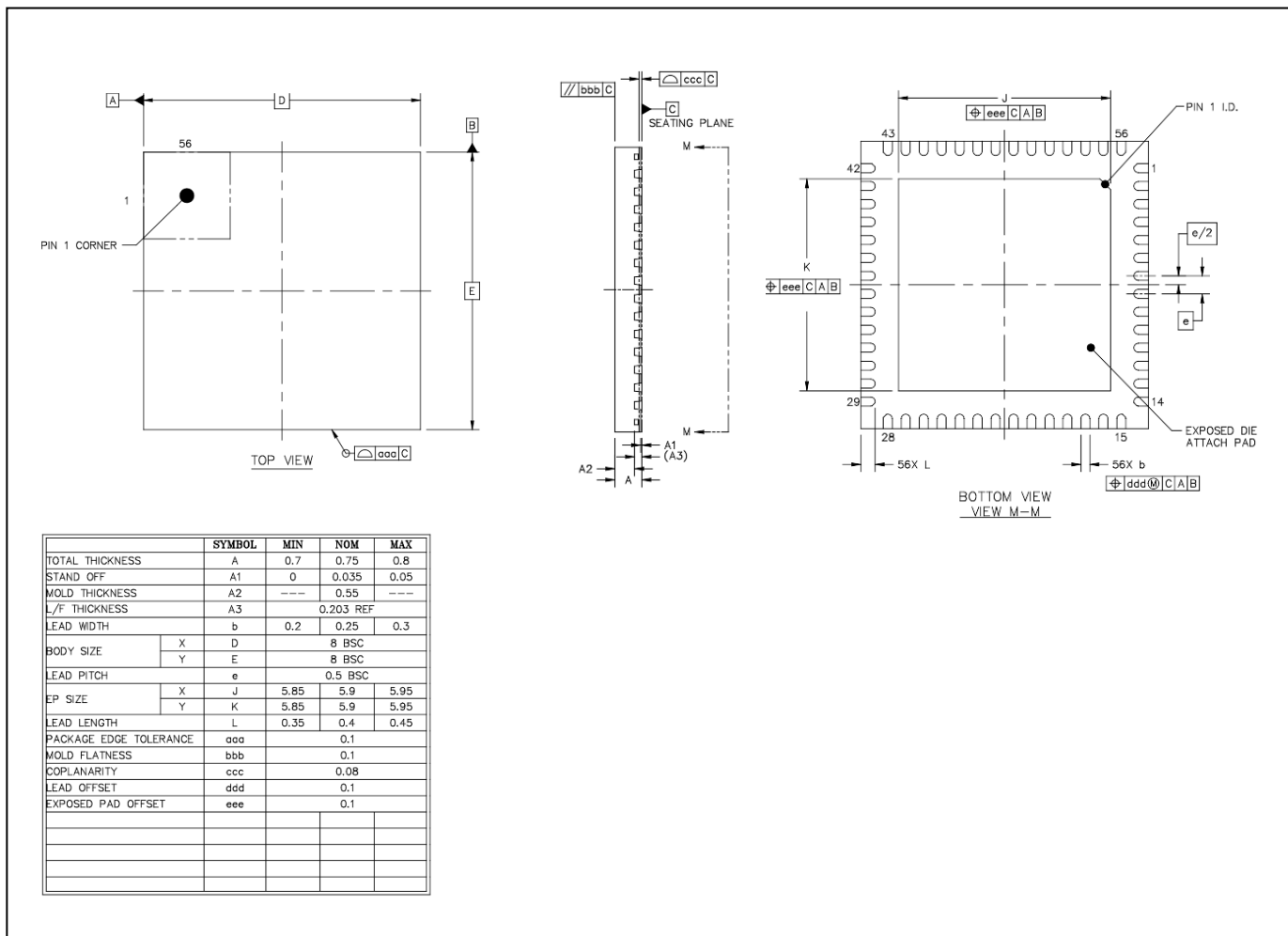
For managing MSL3 Package, it should refer to JEDEC J-STD-020C about floor life management & refer to JEDEC J-STD-033C about re-bake condition while IC's floor life exceeds MSL3 limitation.



Package Thickness	Volume mm <sup>3</sup> <350	Volume mm <sup>3</sup> 350-2000	Volume mm <sup>3</sup> ≥ 2000
<1.6mm	260 +0 °C	260 +0 °C	260 +0 °C
1.6mm – 2.5mm	260 +0 °C	250 +0 °C	245 +0 °C
≥ 2.5mm	250 +0 °C	245 +0 °C	245 +0 °C

\*Note: For details, please refer to Macroblock’s “Policy on Pb-free & Green Package”.

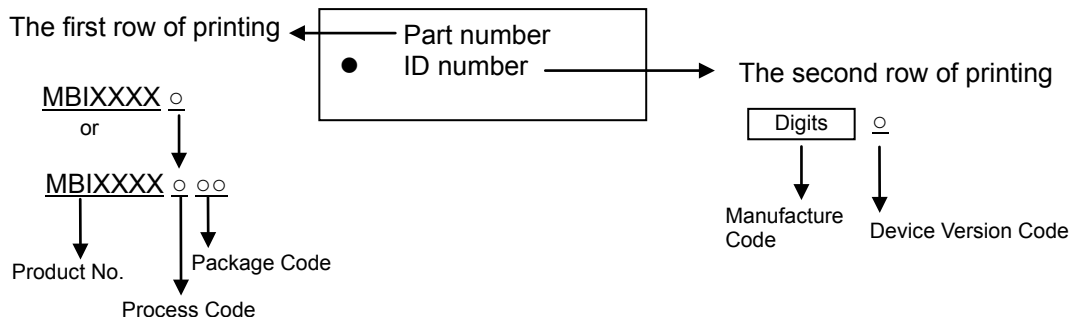
**Package Outline**



MBI5353GFN Outline Drawing

Note: The unit for the outline drawing is mm.

**Product Top Mark Information**



**Product Revision History**

Datasheet Version	Devise Version Code
V1.00	A
V1.01	A

**Product Ordering Information**

Product Ordering Number*	RoHS Compliant Package Type	Weight (g)
MBI5353GFN-A	QFN56L-8*8-0.5	0.15885

\*Please place your order with the “*product ordering number*” information on your purchase order (PO).

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